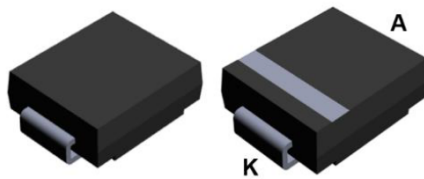
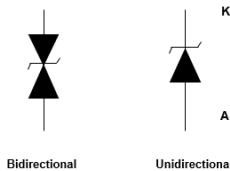


3000 W TVS in SMC



SMC
(JEDEC DO-214AB)



Features

- Peak pulse power:
 - 3000 W (10/1000 μ s)
 - up to 36 kW (8/20 μ s)
- Stand-off voltage range from 5 V to 48 V
- Unidirectional and bidirectional types
- Low leakage current: 0.2 μ A at 25 °C
- Operating T_j max: 175 °C
- JEDEC registered package outline
- Resin meets UL94, V0
- Lead finishing: matte tin plating

Complies with the following standards

- UL94, V0
- J-STD-020 MSL level 1
- J-STD-002, JESD 22-B102 E3 and MIL-STD-750, method 2026
- JESD-201 class 2 whisker test
- IPC7531 footprint and JEDEC registered package outline
- IEC 61000-4-4 level 4:
 - 4 k V
- IEC 61000-4-2, C = 150 pF, R = 330 Ω exceeds level 4:
 - 30 kV (air discharge)
 - 30 kV (contact discharge)

Description

The SMC30J TVS series are designed to protect sensitive equipment against electrostatic discharges according to IEC 61000-4-2, MIL STD 883 Method 3015, and electrical overstress such as IEC 61000-4-4 and 5. They are used for surges below 3000 W 10/1000 μ s.

This planar technology makes it compatible with high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time.

Product status link	
SMC30J	SMC30J5.0A , SMC30J5.0CA , SMC30J6.0A , SMC30J6.0CA , SMC30J6.5A , SMC30J6.5CA , SMC30J8.5A , SMC30J8.5CA , SMC30J10A , SMC30J10CA , SMC30J12A , SMC30J12CA , SMC30J13A , SMC30J13CA , SMC30J15A , SMC30J15CA , SMC30J16A , SMC30J16CA , SMC30J18A , SMC30J18CA , SMC30J20A , SMC30J20CA , SMC30J22A , SMC30J22CA , SMC30J24A , SMC30J24CA , SMC30J26A , SMC30J26CA , SMC30J28A , SMC30J28CA , SMC30J30A , SMC30J30CA , SMC30J33A , SMC30J33CA , SMC30J36A , SMC30J36CA , SMC30J40A , SMC30J40CA , SMC30J48A , SMC30J48CA

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Parameter	Value	Unit	
V_{PP}	Peak pulse voltage	IEC 61000-4-2 (C = 150 pF, R = 330 Ω)	kV	
		Contact discharge		30
		Air discharge		30
P_{PP}	Peak pulse power dissipation	T_j initial = T_{amb}	3000	W
T_{stg}	Storage temperature range		-65 to +175	$^{\circ}\text{C}$
T_j	Operating junction temperature range		-55 to +175	$^{\circ}\text{C}$
T_L	Maximum lead temperature for soldering during 10 s		260	$^{\circ}\text{C}$

Figure 1. Electrical characteristics - parameter definitions

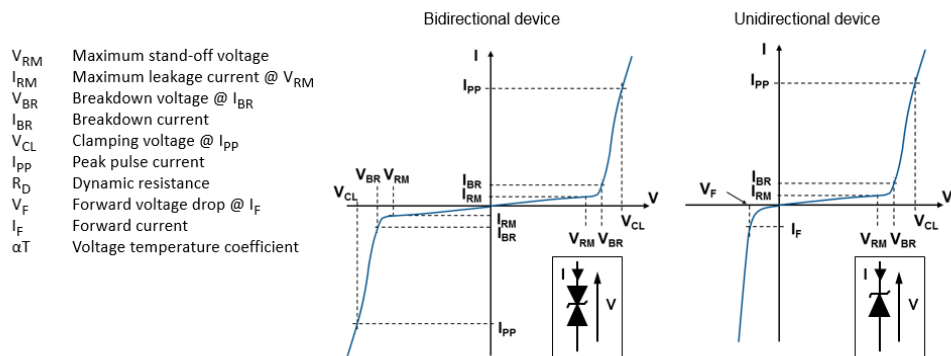


Figure 2. Pulse definition for electrical characteristics

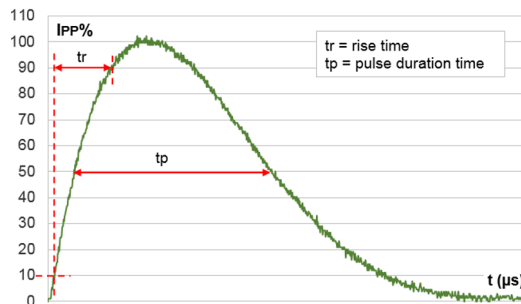


Table 2. Electrical characteristics - parameter values ($T_{amb} = 25\text{ °C}$, unless otherwise specified)

Type	I_{RM} max at V_{RM}		V_{BR} at I_R ⁽¹⁾			10 / 1000 μ s			8 / 20 μ s			αT
						V_{CL} ⁽²⁾⁽³⁾	I_{PP} ⁽⁴⁾	R_D	V_{CL} ⁽²⁾⁽³⁾	I_{PP} ⁽⁴⁾	R_D	
	Min.	Typ.		Max.		Max.	Max.		Max.	Max.		
	μ A	V	V	mA	V	A	Ω	V	A	Ω	$10^{-4}/\text{°C}$	
SMC30J5.0A/CA	500	5	6.4	6.74	10	9.20	327	0.008	14.4	1610	0.005	5.7
SMC30J6.0A/CA	500	6	6.7	7.05	10	10.3	291	0.011	14.7	1580	0.005	5.9
SMC30J6.5A/CA	250	6.5	7.2	7.58	10	11.2	268	0.014	15.2	1530	0.005	6.1
SMC30J8.5A/CA	10	8.5	9.4	9.9	1	14.4	208	0.022	18.6	1280	0.006	7.3
SMC30J10A/CA	0.2	10	11.1	11.7	1	17	176	0.030	21.7	1170	0.008	7.8
SMC30J12A/CA	0.2	12	13.3	14	1	19.9	151	0.039	25.3	1045	0.011	8.3
SMC30J13A/CA	0.2	13	14.4	15.2	1	21.5	140	0.045	27.2	993	0.011	8.4
SMC30J15A/CA	0.2	15	16.7	17.6	1	24.4	123	0.055	32.5	926	0.015	8.8
SMC30J16A/CA	0.2	16	17.8	18.7	1	26	115	0.063	34.4	868	0.017	8.8
SMC30J18A/CA	0.2	18	20	21.1	1	29.2	103	0.079	39.3	800	0.021	9.2
SMC30J20A/CA	0.2	20	22.2	23.4	1	32.4	93	0.097	42.8	747	0.024	9.4
SMC30J22A/CA	0.2	22	24.4	25.7	1	35.5	85	0.115	48.3	701	0.030	9.6
SMC30J24A/CA	0.2	24	26.7	28.1	1	38.9	77	0.140	50.0	660	0.031	9.6
SMC30J26A/CA	0.2	26	28.9	30.4	1	42.1	71	0.165	53.5	626	0.035	9.7
SMC30J28A/CA	0.2	28	31.1	32.7	1	45.4	66	0.192	59.0	596	0.041	9.8
SMC30J30A/CA	0.2	30	33.3	35.1	1	48.4	62	0.215	64.3	569	0.048	9.9
SMC30J33A/CA	0.2	33	36.7	38.6	1	53.3	56	0.263	69.7	526	0.056	10.0
SMC30J36A/CA	0.2	36	40.0	42.1	1	58.1	48.41	0.331	76.0	503	0.063	10.0
SMC30J40A/CA	0.2	40	44.4	46.7	1	64.5	43.5	0.409	84.0	469	0.075	10.1
SMC30J48A/CA	0.2	48	53.2	56.0	1	76.6	38.0	0.542	100	409	0.101	10.3

1. To calculate V_{BR} versus T_j : V_{BR} at $T_j = V_{BR}$ at $25\text{ °C} \times (1 + \alpha T \times (T_j - 25))$
2. To calculate V_{CL} versus T_j : V_{CL} at $T_j = V_{CL}$ at $25\text{ °C} \times (1 + \alpha T \times (T_j - 25))$
3. To calculate V_{CL} max versus I_{PP} appli: $V_{CLmax} = V_{CL} - R_D \times (I_{PP} - I_{PPappli})$ where I_{PP} appli is the surge current in the application
4. Surge capability given for both directions for unidirectional and bidirectional devices

1.1 Characteristics (curves)

Figure 3. Maximum peak power dissipation versus initial junction temperature

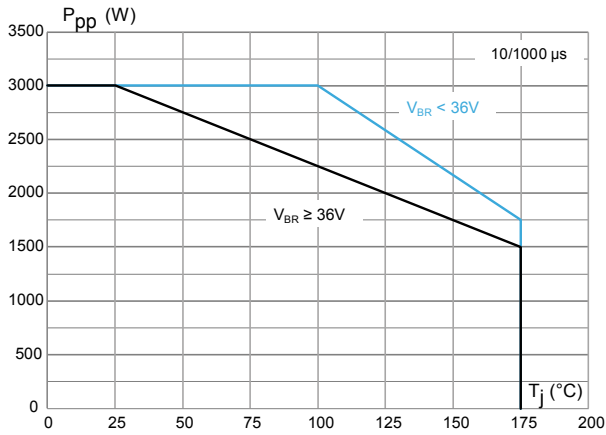


Figure 4. Maximum peak pulse power versus exponential pulse duration

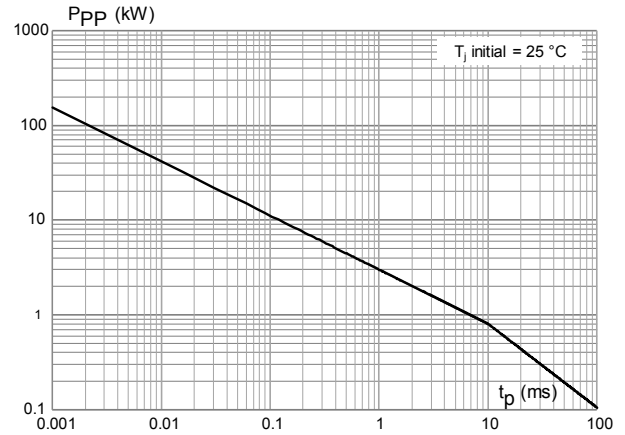


Figure 5. Maximum peak pulse current versus clamping voltage

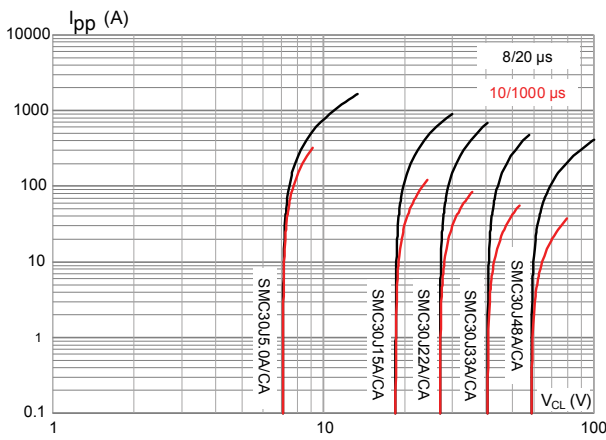


Figure 6. Dynamic resistance versus pulse duration

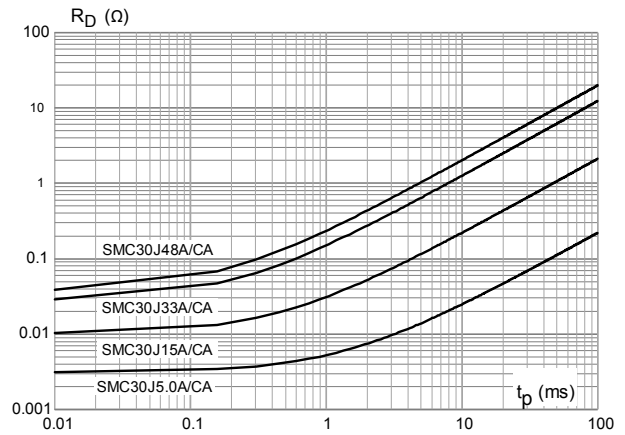


Figure 7. Junction capacitance versus reverse applied voltage (unidirectional type)

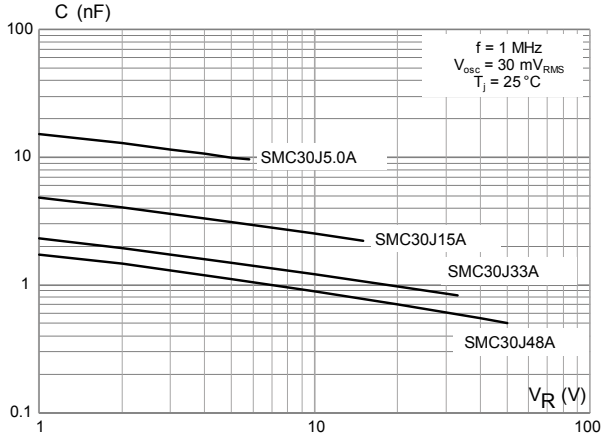


Figure 8. Junction capacitance versus applied voltage (bidirectional type)

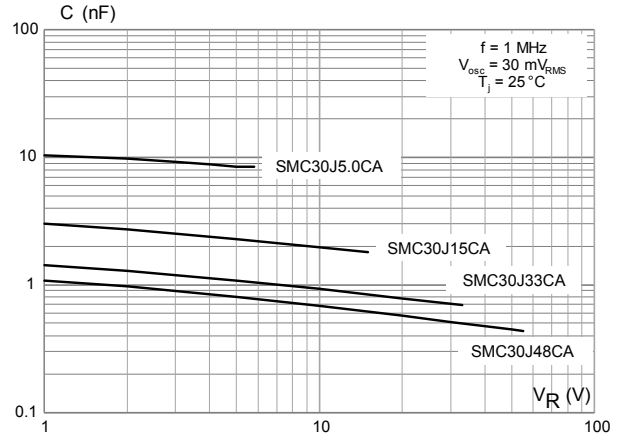


Figure 9. Leakage current versus junction temperature

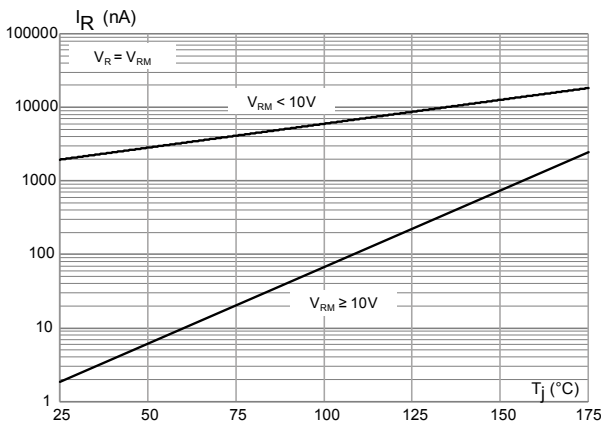


Figure 10. Peak forward voltage drop versus peak forward current

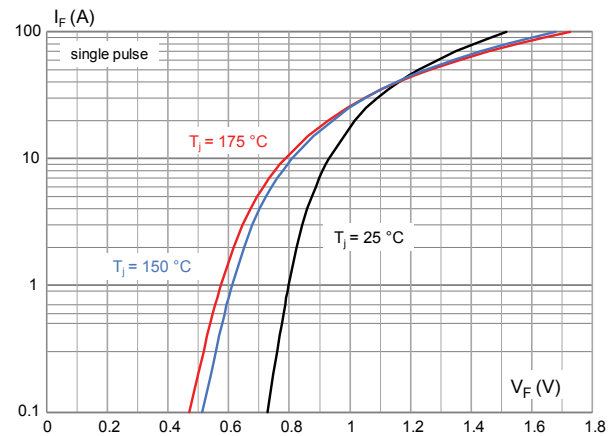


Figure 11. Thermal impedance junction to ambient versus pulse duration

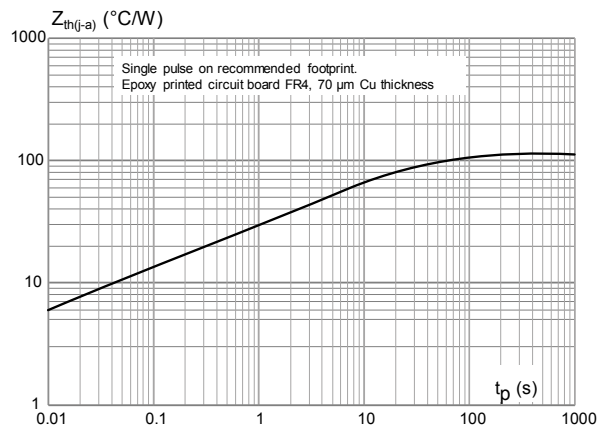
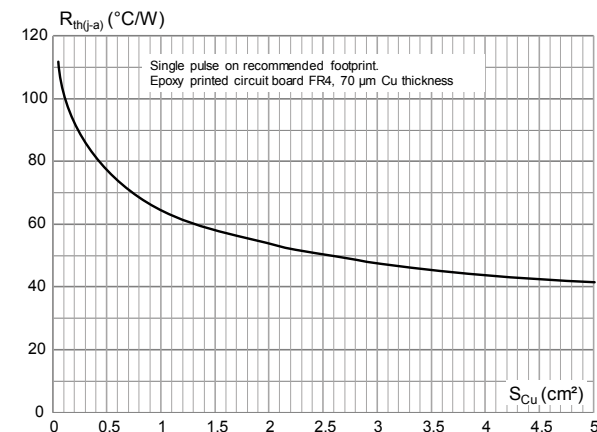


Figure 12. Thermal resistance junction to ambient versus copper area under each lead



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMC package information

- Epoxy meets UL94, V0

Figure 13. SMC package outline

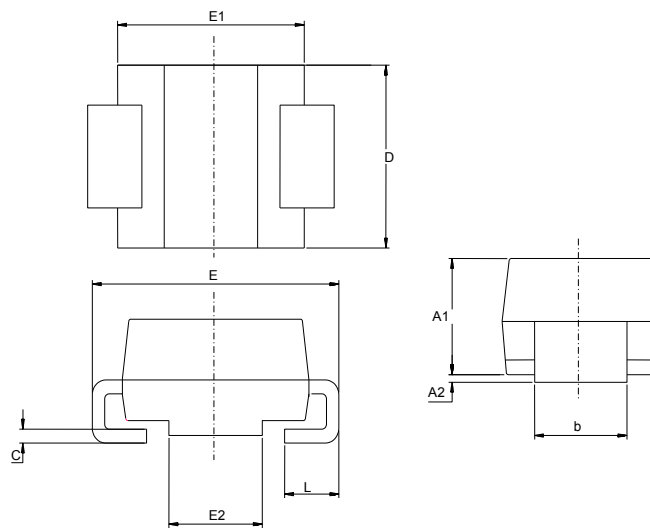


Table 3. SMC package mechanical data

Ref.	Dimensions			
	Millimeters		Inches (for reference only)	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.40	0.006	0.016
D	5.55	6.25	0.218	0.246
E	7.75	8.15	0.305	0.321
E1	6.60	7.15	0.260	0.281
E2	4.40	4.70	0.173	0.185
L	0.75	1.50	0.030	0.060

Figure 14. Footprint recommendation

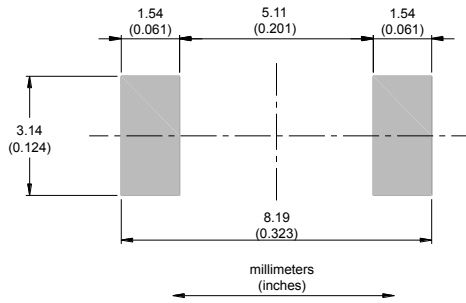


Figure 15. Marking layout

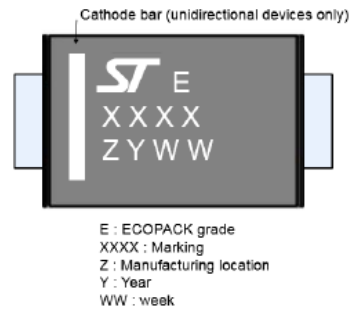
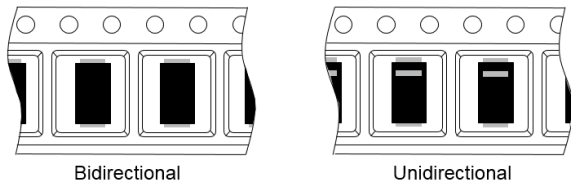


Figure 16. Package orientation in reel



Taped according to EIA-481
Pocket dimensions are not on scale.
Pocket shape may vary depending on package
On bidirectional devices, marking and logo may not be always in the same direction.

Figure 17. Tape and reel orientation

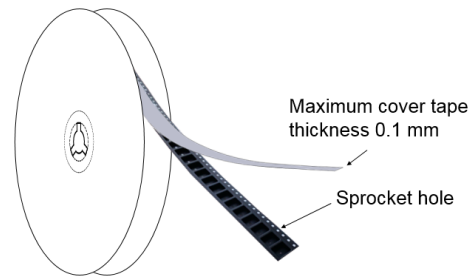


Figure 18. 13" reel dimension values (mm)

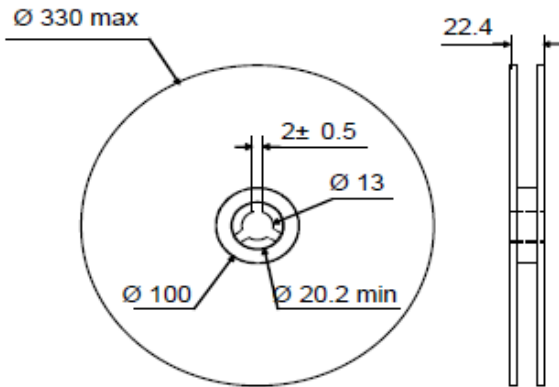


Figure 19. Inner box dimension values (mm)

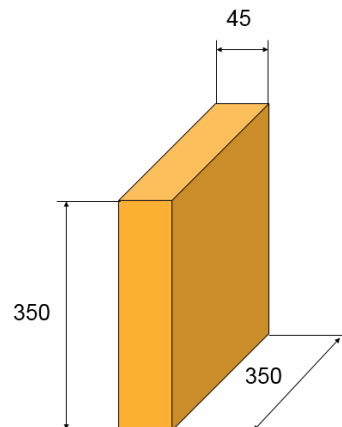
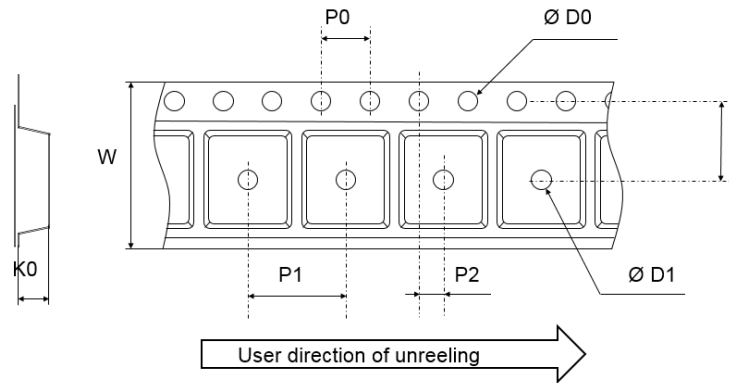


Figure 20. Tape outline



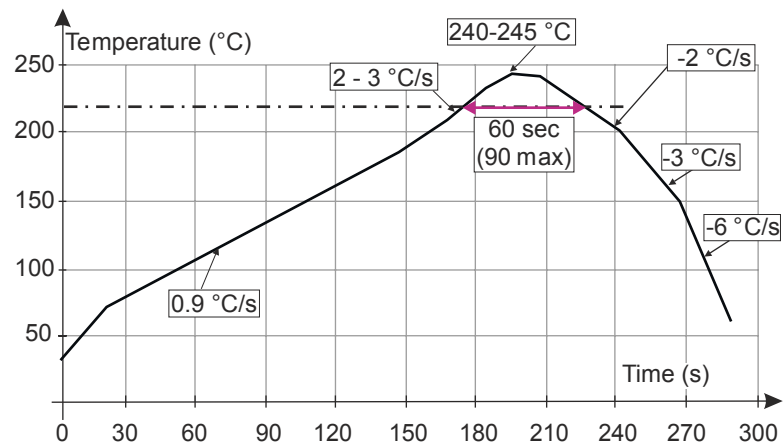
Note: Pocket dimensions are not on scale
Pocket shape may vary depending on package

Table 4. Tape dimension values

Ref.	Dimensions		
	Millimeters		
	Min.	Typ.	Max.
D0	1.4	1.5	1.6
D1	1.5		
F	7.4	7.5	7.6
K0	2.39	2.49	2.59
P0	3.9	4.0	4.1
P1	7.9	8.0	8.1
P2	1.9	2.0	2.1
W	15.7	16	16.3

2.2 Reflow profile

Figure 21. ST ECOPACK recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

3 Ordering information

Figure 22. Ordering information scheme

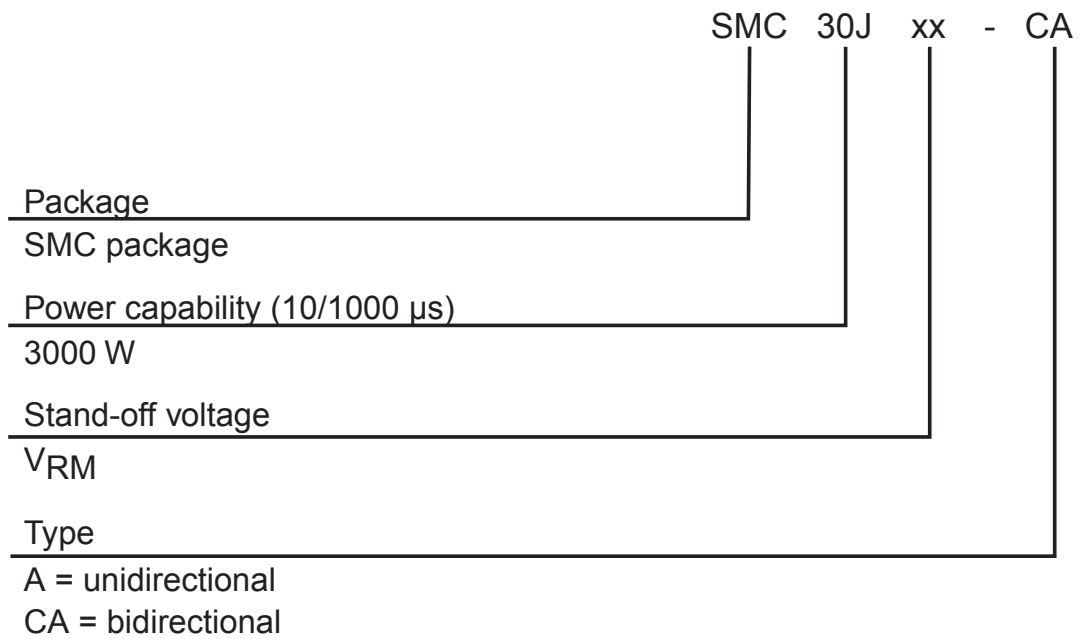


Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
SMC30JxxA/CA ⁽¹⁾	See Table 6. Marking	SMC	0.25 g	2500	Tape and reel

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version.

Table 6. Marking

Order code	Marking	Order code	Marking
SMC30J5.0A	3AAA	SMC30J5.0CA	3BAA
SMC30J6.0A	3AAB	SMC30J6.0CA	3BAB
SMC30J6.5A	3AAC	SMC30J6.5CA	3BAC
SMC30J8.5A	3AAD	SMC30J8.5CA	3BAD
SMC30J10A	3AAW	SMC30J10CA	3BAW
SMC30J12A	3AAF	SMC30J12CA	3BAF
SMC30J13A	3AAG	SMC30J13CA	3BAG
SMC30J15A	3AAH	SMC30J15CA	3BAH
SMC30J16A	3AAI	SMC30J16CA	3BAI
SMC30J18A	3AAJ	SMC30J18CA	3BAJ
SMC30J20A	3AAK	SMC30J20CA	3BAK
SMC30J22A	3AAL	SMC30J22CA	3BAL
SMC30J24A	3AAE	SMC30J24CA	3BAE
SMC30J26A	3AAM	SMC30J26CA	3BAM
SMC30J28A	3AAN	SMC30J28CA	3BAN
SMC30J30A	3AAO	SMC30J30CA	3BAO
SMC30J33A	3AAP	SMC30J33CA	3BAP
SMC30J36A	3AAQ	SMC30J36CA	3BAQ
SMC30J40A	3AAR	SMC30J40CA	3BAR
SMC30J48A	3AAS	SMC30J48CA	3BAS

Revision history

Table 7. Document revision history

Date	Version	Changes
28-Jul-2011	1	Initial release.
15-Jul-2015	2	Updated features on cover page. Updated Table 1, Figure 3, Figure 5, Figure 6, Figure 7, Figure 8, Figure 10 and Figure 11. Updated Table 5.
22-Jul-2015	3	Updated Figure 9.
12-Nov-2019	4	Updated front page, Table 2. Electrical characteristics - parameter values ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) and Section 1.1 Characteristics (curves).
10-Mar-2020	5	Updated Table 2. Electrical characteristics - parameter values ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified).

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